

zQSFP+/QSFP28

TE Internal #: 1551892-2

QSFP28/56, Cage Assembly, Signal, Operating Temperature Range

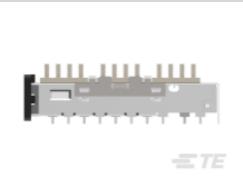
-55 – 105 °C [-67 – 221 °F], Data Rate (Max) 25 Gb/s, 1 Ports

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Connectors > Pluggable IO Connectors & Cages











Pluggable I/O Product Type: Cage Assembly

Sealable: No

Circuit Application: Signal

Operating Temperature Range: -55 - 105 °C [-67 - 221 °F]

Data Rate (Max): 25 Gb/s

Features

Product Type Features

Thermal Accessory Type Included	Heat Sink
Cage Type	Single
Pluggable I/O Product Type	Cage Assembly
Sealable	No
Form Factor	QSFP28/56

Configuration Features

Number of Rear EONs per Port Column	2
Number of Ports	1
Port Matrix Configuration	1 x 1

Electrical Characteristics

Data Rate (Max)	25 Gb/s
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Body Features

Heat Sink Finish	Anodized Black
Heat Sink Height	6.5 mm[.256 in]



Heat Sink Height Class	SAN
Heat Sink Style	Pin
Contact Features	
PCB Contact Termination Area Plating Material	Tin
Termination Features	
Termination Post & Tail Length	2.05 mm[.081 in]
Termination Method to Printed Circuit Board	
remination Method to Printed Circuit Board	Through Hole - Press-Fit
Housing Features	
Cage Material	Nickel Silver
Dimensions	
PCB Thickness (Recommended)	1.45 mm[.057 in]
Usage Conditions	
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Operation/Application	
Pluggable I/O Applications	SFP+ Stacked Belly-to-Belly
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Method	Box & Tray
Other	
Included Lightpipe	No
EMI Containment Feature Type	Customer Applied Gasket

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2024 (240)



	Candidate List Declared Against: JAN 2024 (240) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

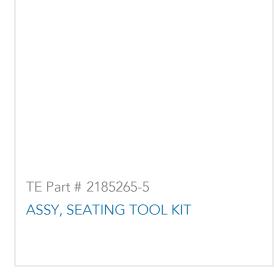
Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

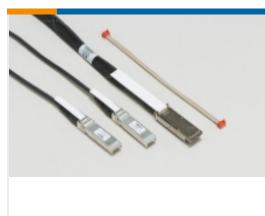






Also in the Series | zQSFP+/QSFP28









Customers Also Bought















Documents

Product Drawings

Cage Assy Behind Bezel QSFP28

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_1551892-2_C.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1551892-2_C.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1551892-2_C.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

QSFP28/56 and zQSFP+ Interconnects

English

Product Specifications

Application Specification

English

Application Specification

English

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